



# 100V 5.3mΩ N-Ch Power MOSFET

## Features

- Ultra-low  $R_{DS(ON)}$
- Low Gate Charge
- 100% UIS Tested, 100%  $R_g$  Tested
- Pb-free Lead Plating
- Halogen-free and RoHS-compliant

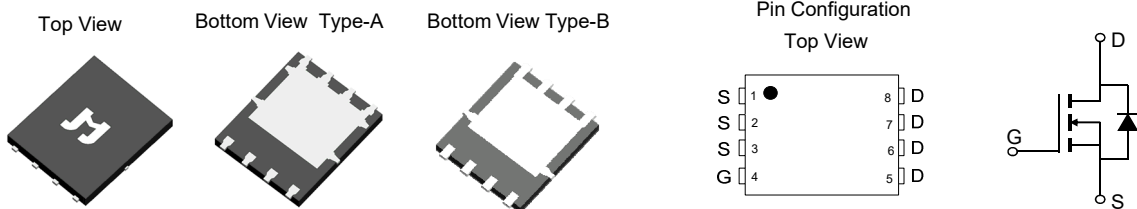
## Product Summary

Parameter	Value	Unit
$V_{DS}$	100	V
$V_{GS(th\_Typ)}$	2.7	V
$I_D$ (@ $V_{GS} = 10V$ ) <sup>(1)</sup>	102	A
$R_{DS(ON)\_Typ}$ (@ $V_{GS} = 10V$ )	5.3	mΩ

## Applications

- Power Management in Telecom., Industrial Automation, CE
- Current Switching in DC/DC & AC/DC (SR) Sub-systems
- Motor Driving in Power Tool, E-vehicle, Robotics

PDFN5x6-8L

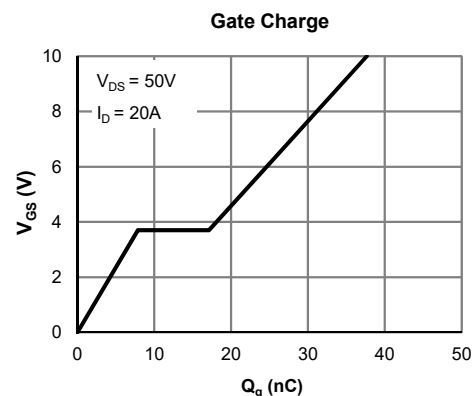
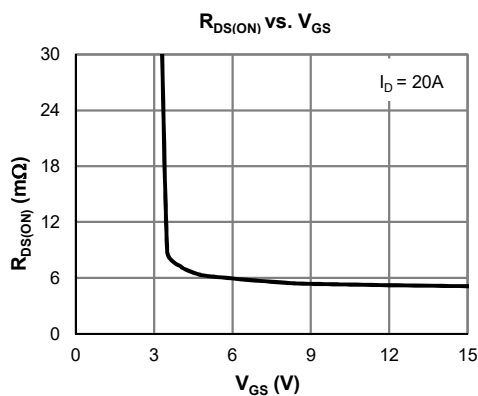


## Ordering Information

Device	Package	# of Pins	Marking	MSL	$T_J$ (°C)	Media	Quantity (pcs)
JMSH1006AG-13	PDFN5x6-8L	8	SH1006A	1	-55 to 150	13-inch Reel	5000

## Absolute Maximum Ratings (@ $T_A = 25^\circ C$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{DS}$	100	V
Gate-to-Source Voltage	$V_{GS}$	±20	V
Continuous Drain Current <sup>(1)</sup>	$I_D$	$T_C = 25^\circ C$	102
		$T_C = 100^\circ C$	64
Pulsed Drain Current <sup>(2)</sup>	$I_{DM}$	366	A
Avalanche Current <sup>(3)</sup>	$I_{AS}$	47	A
Avalanche Energy <sup>(3)</sup>	$E_{AS}$	110	mJ
Power Dissipation <sup>(4)</sup>	$P_D$	$T_C = 25^\circ C$	130
		$T_C = 100^\circ C$	52
Junction & Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C



**Electrical Characteristics** (@  $T_J = 25^\circ\text{C}$  unless otherwise specified)

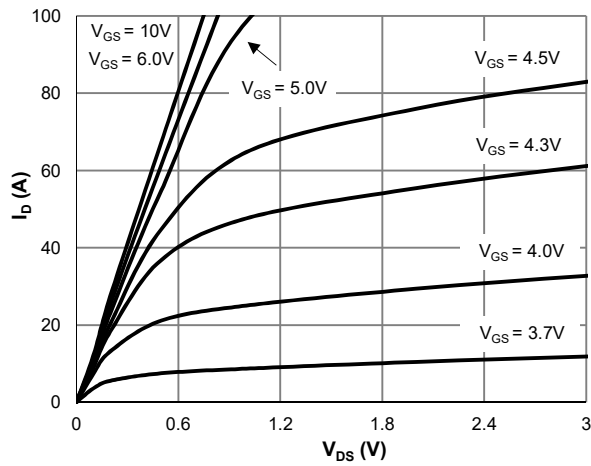
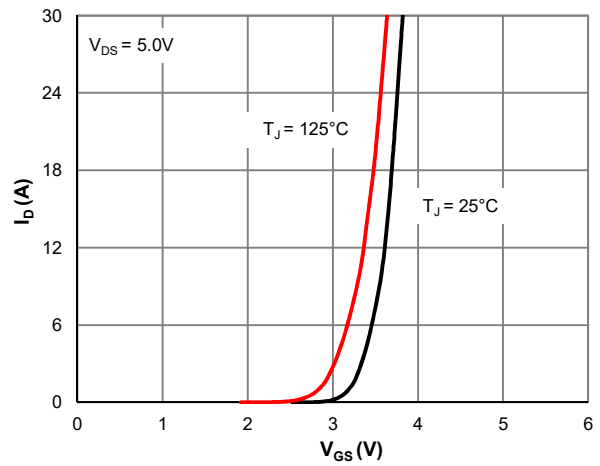
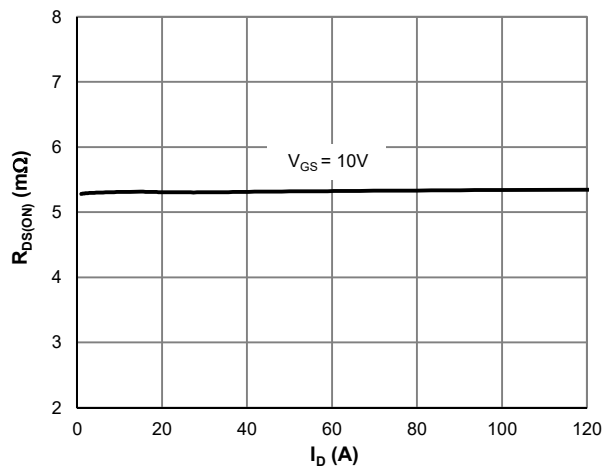
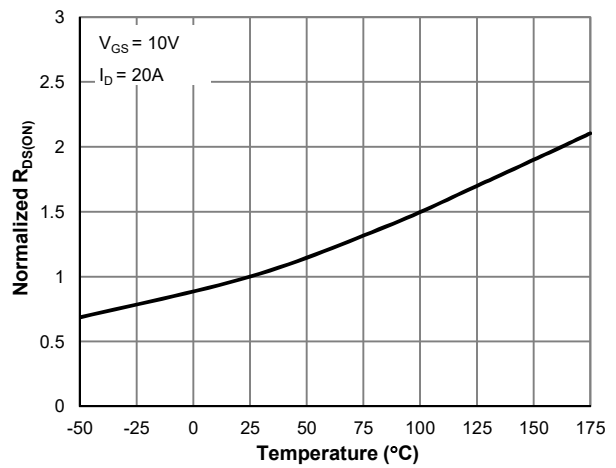
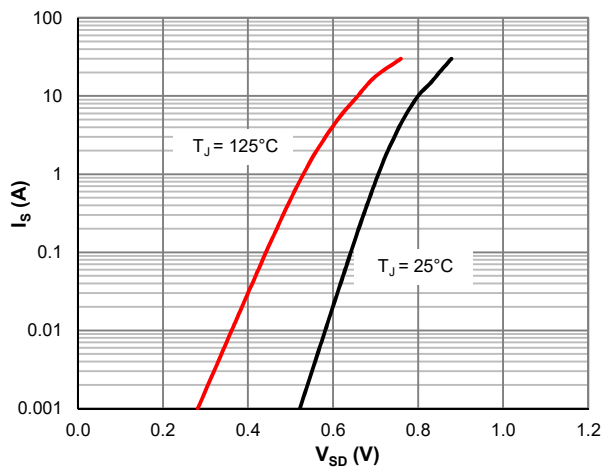
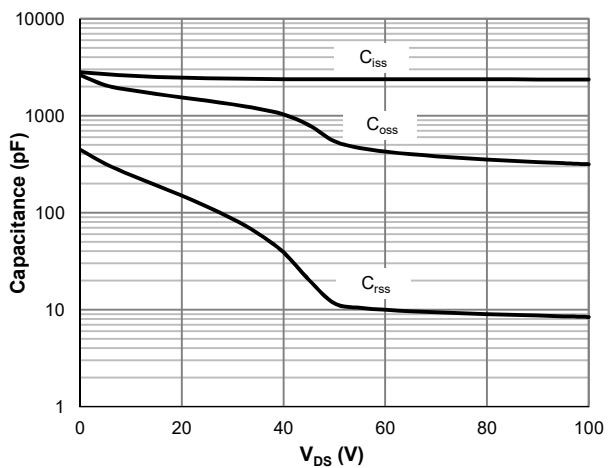
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 250\mu\text{A}$ , $V_{GS} = 0\text{V}$	100			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 80\text{V}$ , $V_{GS} = 0\text{V}$ $T_J = 55^\circ\text{C}$			1.0 5.0	$\mu\text{A}$
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{V}$ , $V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250\mu\text{A}$	2.0	2.7	4.0	V
Static Drain-Source ON-Resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{V}$ , $I_D = 20\text{A}$		5.3	6.6	$\text{m}\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 5\text{V}$ , $I_D = 20\text{A}$		81		S
Diode Forward Voltage	$V_{SD}$	$I_S = 1\text{A}$ , $V_{GS} = 0\text{V}$		0.71	1.0	V
Diode Continuous Current	$I_S$	$T_C = 25^\circ\text{C}$			130	A
<b>DYNAMIC PARAMETERS</b> <sup>(5)</sup>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 50\text{V}$ , $f = 1\text{MHz}$		2369		pF
Output Capacitance	$C_{oss}$			545		pF
Reverse Transfer Capacitance	$C_{rss}$			11.6		pF
Gate Resistance	$R_g$	$V_{GS} = 0\text{V}$ , $V_{DS} = 0\text{V}$ , $f = 1\text{MHz}$		1.9		$\Omega$
<b>SWITCHING PARAMETERS</b> <sup>(5)</sup>						
Total Gate Charge (@ $V_{GS} = 10\text{V}$ )	$Q_g$	$V_{GS} = 0$ to $10\text{V}$ $V_{DS} = 50\text{V}$ , $I_D = 20\text{A}$		38		nC
Total Gate Charge (@ $V_{GS} = 4.5\text{V}$ )	$Q_g$			25		nC
Gate Source Charge	$Q_{gs}$			7.9		nC
Gate Drain Charge	$Q_{gd}$			9.2		nC
Turn-On Delay Time	$t_{D(on)}$	$V_{GS} = 10\text{V}$ , $V_{DS} = 50\text{V}$ $R_L = 2.5\Omega$ , $R_{GEN} = 6\Omega$		12.6		ns
Turn-On Rise Time	$t_r$			29		ns
Turn-Off Delay Time	$t_{D(off)}$			40		ns
Turn-Off Fall Time	$t_f$			44		ns
Body Diode Reverse Recovery Time	$t_{rr}$		$I_F = 15\text{A}$ , $di_F/dt = 100\text{A}/\mu\text{s}$		47	
Body Diode Reverse Recovery Charge	$Q_{rr}$	$I_F = 15\text{A}$ , $di_F/dt = 100\text{A}/\mu\text{s}$		52		nC

**Thermal Performance**

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	50	65	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.74	0.96	$^\circ\text{C}/\text{W}$

**Notes:**

1. Computed continuous current assumes the condition of  $T_{J\_Max}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under  $T_{J\_Max} = 150^\circ\text{C}$ .
3. This single-pulse measurement was taken under the following condition [ $L = 100\mu\text{H}$ ,  $V_{GS} = 10\text{V}$ ,  $V_{DS} = 50\text{V}$ ] while its value is limited by  $T_{J\_Max} = 150^\circ\text{C}$ .
4. The power dissipation  $P_D$  is based on  $T_{J\_Max} = 150^\circ\text{C}$ .
5. This value is guaranteed by design hence it is not included in the production test.

**Typical Electrical & Thermal Characteristics**

**Figure 1: Saturation Characteristics**

**Figure 2: Transfer Characteristics**

**Figure 3:  $R_{DS(ON)}$  vs. Drain Current**

**Figure 4:  $R_{DS(ON)}$  vs. Junction Temperature**

**Figure 5: Body-Diode Characteristics**

**Figure 6: Capacitance Characteristics**

Typical Electrical & Thermal Characteristics

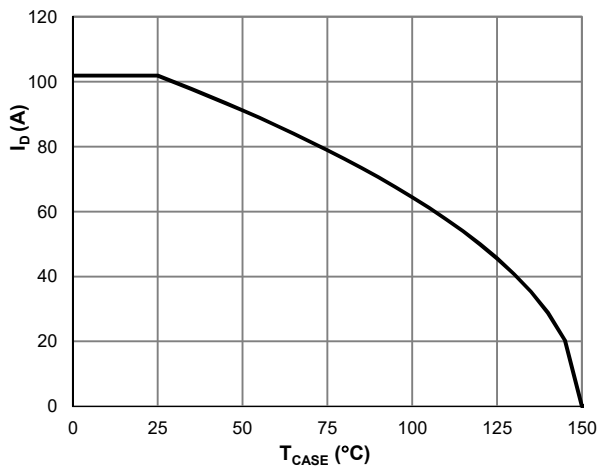


Figure 7: Current De-rating

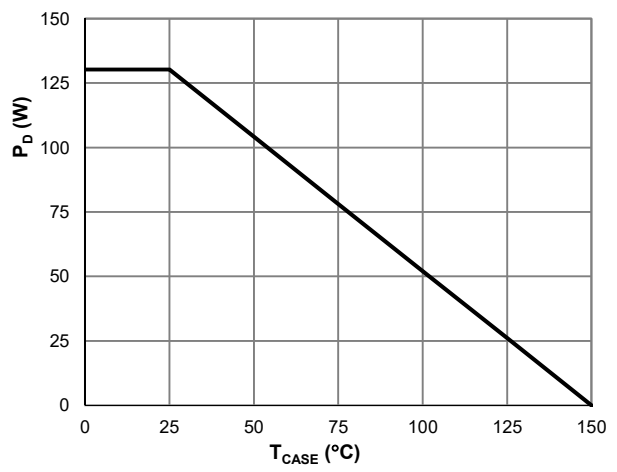


Figure 8: Power De-rating

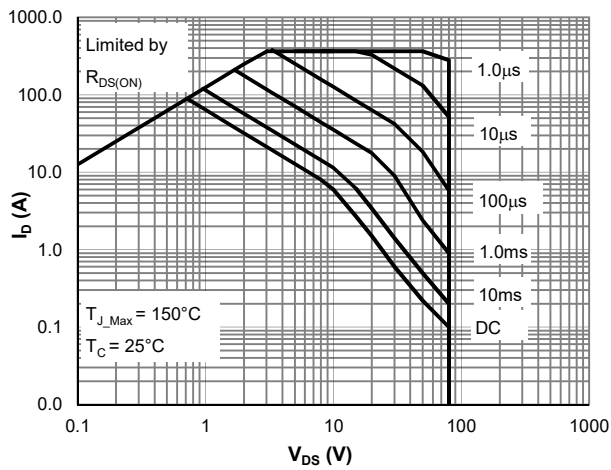


Figure 9: Maximum Safe Operating Area

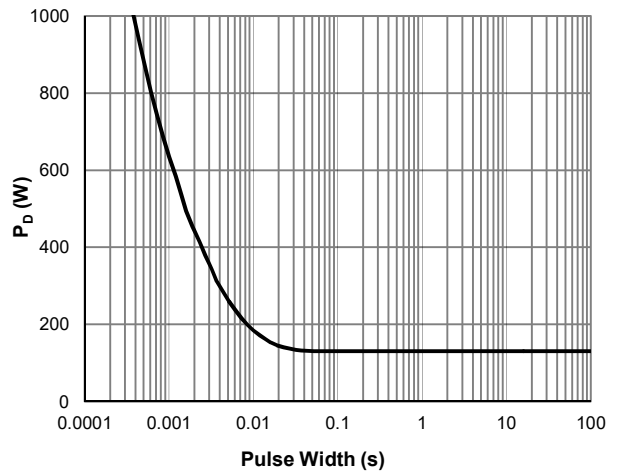


Figure 10: Single Pulse Power Rating, Junction-to-Case

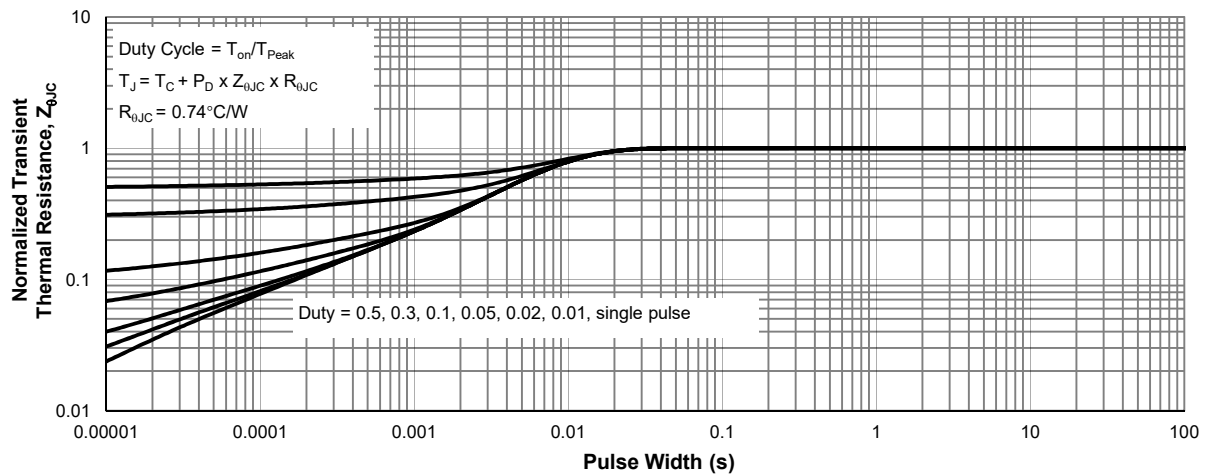
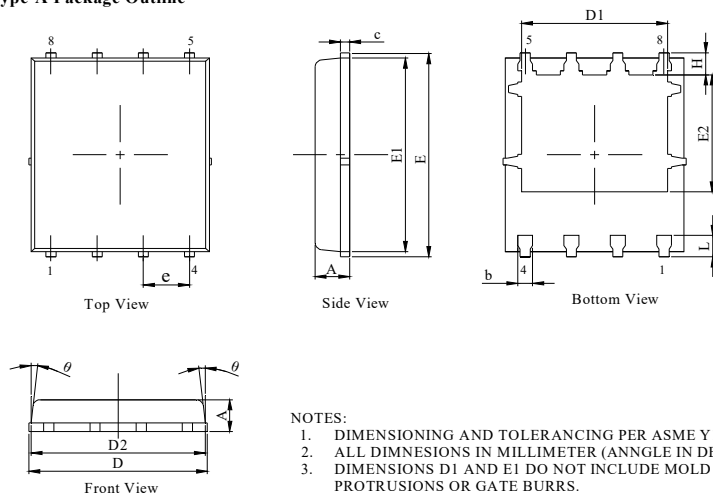
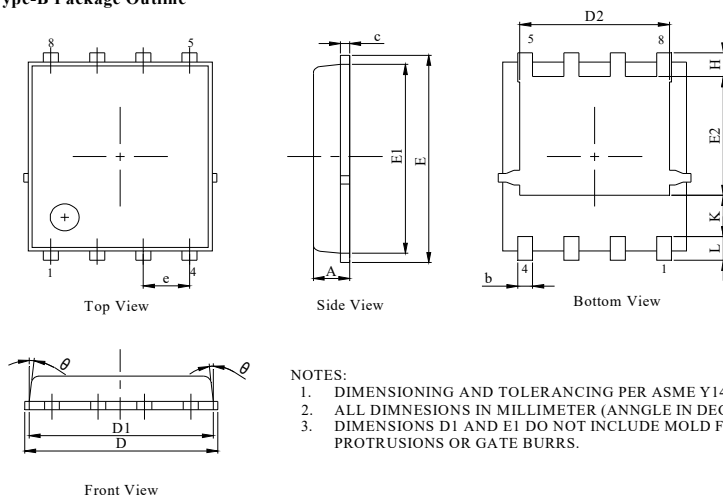


Figure 11: Normalized Maximum Transient Thermal Impedance

**PDFN5x6-8L Package Information**
**Type-A Package Outline**


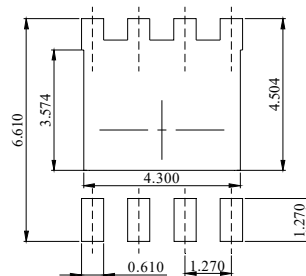
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M,1994.
  2. ALL DIMENSIONS IN MILLIMETER (ANNGLE IN DEGREE).
  3. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS.

DIM.	MILLIMETER		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
b	0.20	0.30	0.40
c	0.21	0.25	0.34
D	4.90	5.00	5.10
D1	3.91	4.01	4.11
D2	4.80	4.90	5.00
E	5.90	6.00	6.10
E1	5.65	5.75	5.85
E2	3.37	3.48	3.58
e	1.27BSC		
H	0.55	0.65	0.75
L	0.55	0.65	0.75
θ	0°	--	12°

**Type-B Package Outline**


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M,1994.
  2. ALL DIMENSIONS IN MILLIMETER (ANNGLE IN DEGREE).
  3. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS.

DIM.	MILLIMETER		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
b	0.31	0.41	0.51
c	0.20	0.25	0.30
D	5.00	5.20	5.40
D1	4.95	5.05	5.15
D2	4.00	4.10	4.20
E	6.05	6.15	6.25
E1	5.50	5.60	5.70
E2	3.42	3.53	3.63
e	1.27BSC		
H	0.60	0.70	0.80
L	0.50	0.70	0.80
θ	-	-	10°

**Recommended Soldering Footprint**


DIMENSIONS: MILLIMETERS